

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Lieb et al.
Serial No.: 10/511,566
For: PROCESS FOR FORMING A HOUSING FOR ELECTRONIC
MODULES, AND ELECTRONIC MODULES ECAPSULATED IN
THIS WAY
Filed: April 13, 2005
Examiner: Andrew O. Arena
Art Unit: 2811
Confirmation No.: 4191
Customer No.: 27,623

Attorney Docket No.: 2133.063USU

**Mail Stop ISSUE FEE
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450**

**AMENDMENT IN RESPONSE TO
THE NOTICE TO FILE CORRECTED APPLICATION PAPERS**

Dear Sir:

In response to the Notice to File Corrected Application Papers dated November 9, 2010, please amend the above-identified application as follows:

Amendments to the Drawings begin on page **2** of this paper.

Remarks begin on page **3** of this paper.